

18A, 600V N-CHANNEL MOSFET

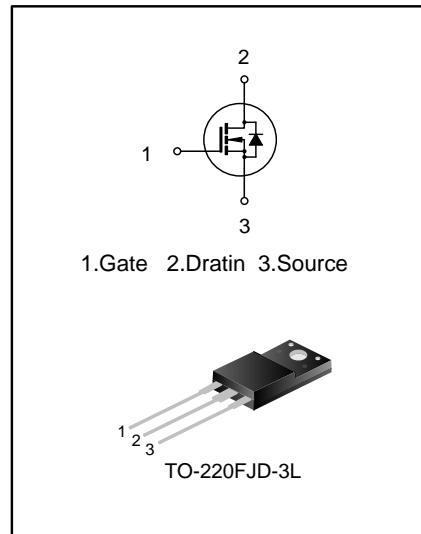
GENERAL DESCRIPTION

SVFP18N60FJD is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan proprietary F-Cell™ structure VDMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

These devices are widely used in AC-DC power supplies, DC-DC converters and H-bridge PWM motor drivers.

FEATURES

- 18A,600V, $R_{DS(on)(typ.)}=0.36\Omega @ V_{GS}=10V$
- Low gate charge
- Low Crss
- Fast switching
- Improved dv/dt capability



ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVFP18N60FJD	TO-220FJD-3L	P18N60FJD	Halogen free	Tube



ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Characteristics		Symbol	Ratings	Unit
Drain-Source Voltage		V_{DS}	600	V
Gate-Source Voltage		V_{GS}	± 30	V
Drain Current	$T_C=25^\circ\text{C}$	I_D	18	A
	$T_C=100^\circ\text{C}$		11	
Drain Current Pulsed		I_{DM}	72	A
Power Dissipation($T_C=25^\circ\text{C}$) -Derate above 25°C		P_D	54	W
			0.43	W/ $^\circ\text{C}$
Single Pulsed Avalanche Energy(Note 1)		E_{AS}	1185	mJ
Reverse Diode dv/dt (Note 2)		dv/dt	4.5	V/ns
MOSFET dv/dt Ruggedness (Note 3)		dv/dt	50	V/ns
Operation Junction Temperature Range		T_J	-55~+150	$^\circ\text{C}$
Storage Temperature Range		T_{stg}	-55~+150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristics	Symbol	Ratings	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.31	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain -Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	600	--	--	V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=600\text{V}$, $V_{GS}=0\text{V}$	--	--	1.0	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 30\text{V}$, $V_{DS}=0\text{V}$	--	--	± 100	nA
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{GS}=V_{DS}$, $I_D=250\mu\text{A}$	2.0	--	4.0	V
Static Drain- Source On State Resistance	$R_{DS(on)}$	$V_{GS}=10\text{V}$, $I_D=9.0\text{A}$	--	0.36	0.45	Ω
Gate Resistance	R_g	f=1.0MHz	--	5.0	--	Ω
Input Capacitance	C_{iss}	$V_{DS}=25\text{V}$, $V_{GS}=0\text{V}$, f=1.0MHz	--	2395	--	pF
Output Capacitance	C_{oss}		--	250	--	
Reverse Transfer Capacitance	C_{rss}		--	7.9	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=300\text{V}$, $I_D=18\text{A}$, $R_G=25\Omega$, (Note4,5)	--	39	--	ns
Turn-on Rise Time	t_r		--	60	--	
Turn-off Delay Time	$t_{d(off)}$		--	128	--	
Turn-off Fall Time	t_f		--	56	--	
Total Gate Charge	Q_g	$V_{DS}=480\text{V}$, $I_D=18\text{A}$, $V_{GS}=10\text{V}$, (Note4,5)	--	46	--	nC
Gate-Source Charge	Q_{gs}		--	17	--	
Gate-Drain Charge	Q_{gd}		--	15	--	



SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	I _S	Integral Reverse P-N Junction Diode in the MOSFET	--	--	18	A
Pulsed Source Current	I _{SM}		--	--	72	
Diode Forward Voltage	V _{SD}	I _S =18 A, V _{GS} =0V	--	--	1.4	V
Reverse Recovery Time	T _{rr}	I _S =18A, V _{GS} =0V, dI _F /dt=100A/μs (Note 4)	--	616	--	ns
Reverse Recovery Charge	Q _{rr}		--	7.40	--	μC

Notes:

1. L=30mH, I_{AS}=8.25A, V_{DD}=50V, R_G=25Ω, starting temperature T_J=25°C;
2. V_{DS}=0~400V, I_{SD}<=18A, T_J=25°C;
3. V_{DS}=0~480V;
4. Pulse Test: Pulse width ≤300μs, Duty cycle≤2%;
5. Essentially independent of operating temperature.



TYPICAL CHARACTERISTICS

Figure 1. On-Region Characteristics

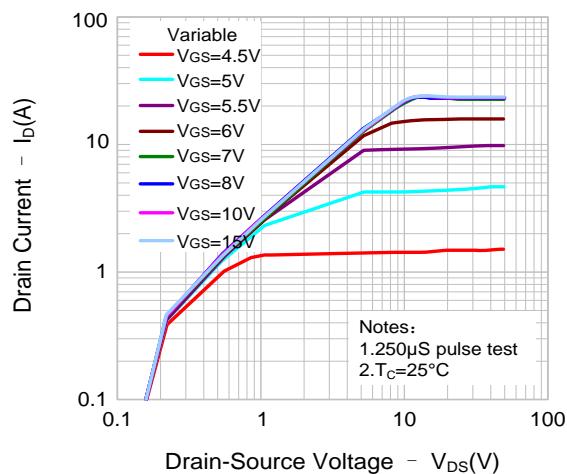


Figure 2. Transfer Characteristics

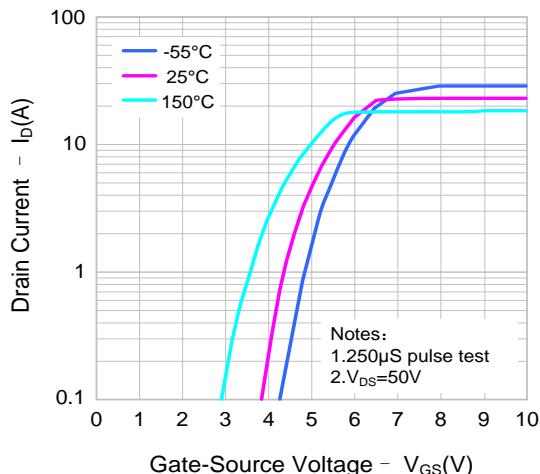


Figure 3. On-Resistance Variation vs.
Drain Current and Gate Voltage

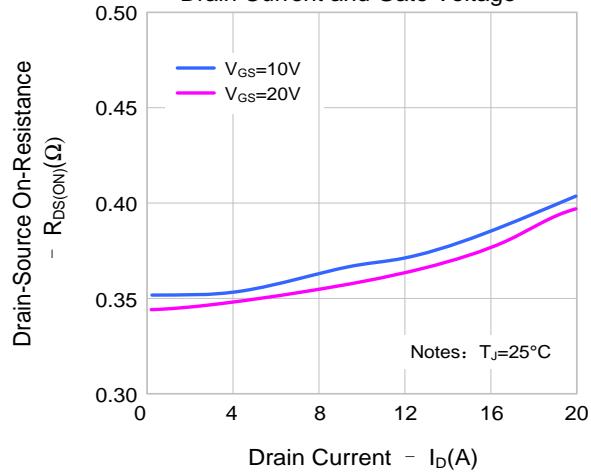


Figure 4. Body Diode Forward Voltage
Variation vs. Source Current and Temperature

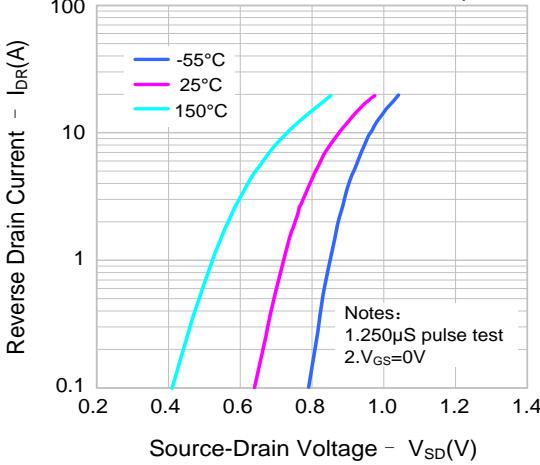


Figure 5. Capacitance Characteristics

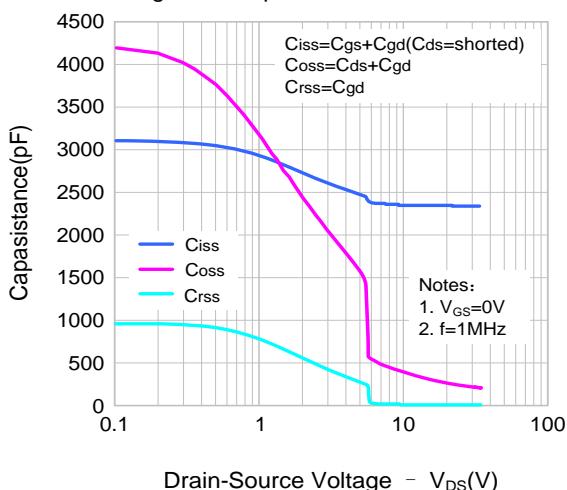
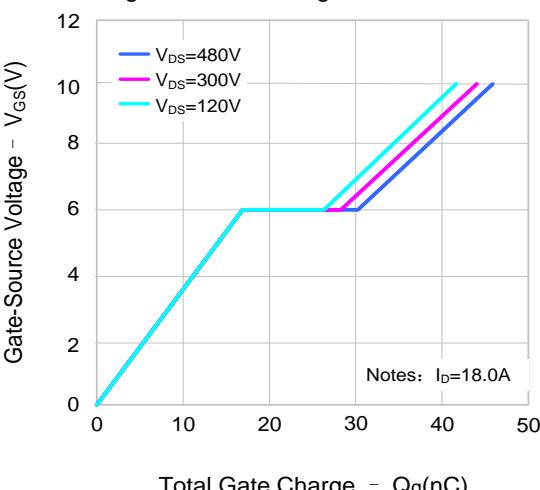


Figure 6. Gate Charge Characteristics



TYPICAL CHARACTERISTICS(CONTINUED)

Figure 7. Breakdown Voltage Variation vs. Temperature

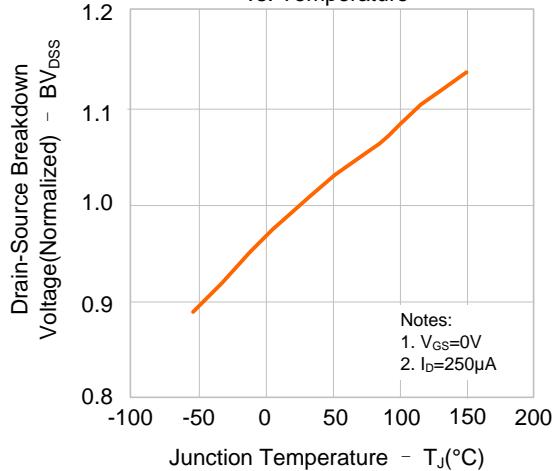


Figure 8. On-resistance Variation vs. Temperature

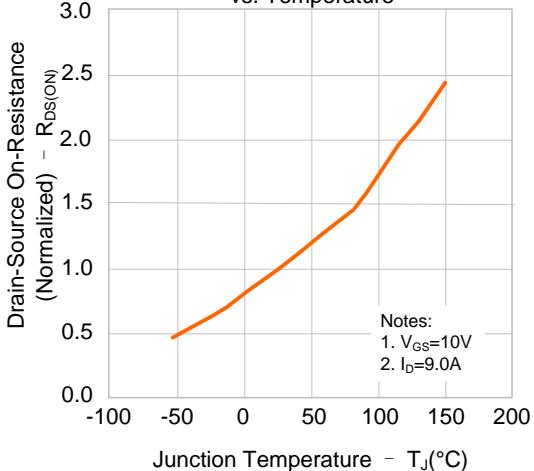


Figure 9. Max. Safe Operating Area

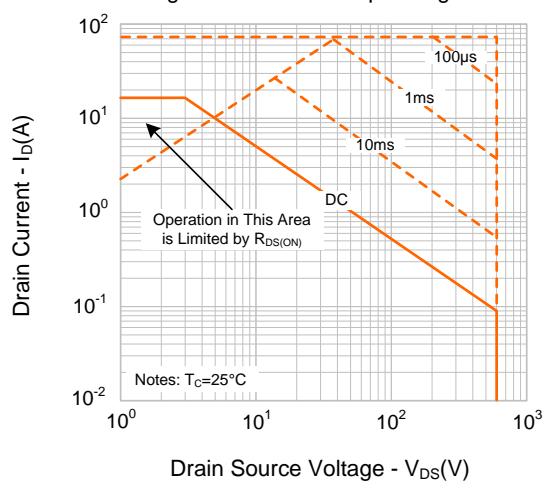
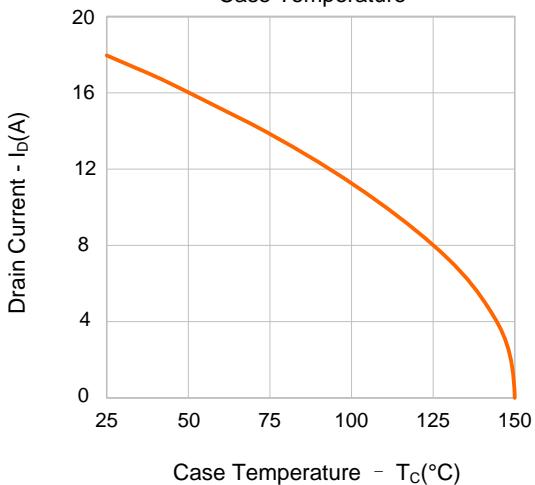
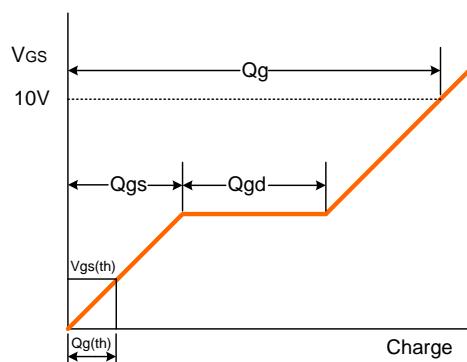
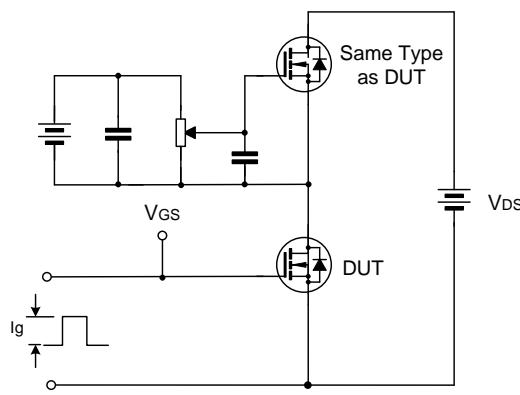


Figure 10. Maximum Drain Current vs. Case Temperature

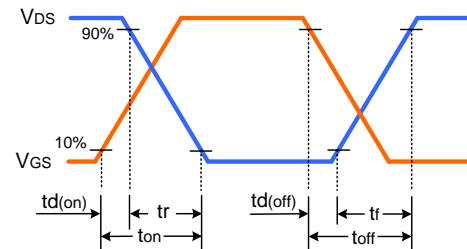
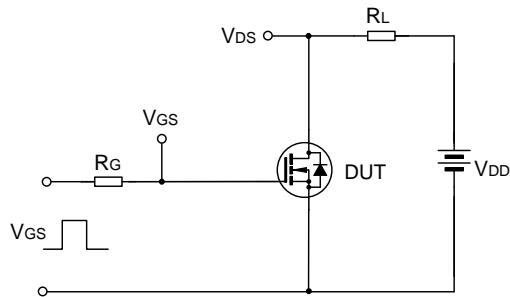




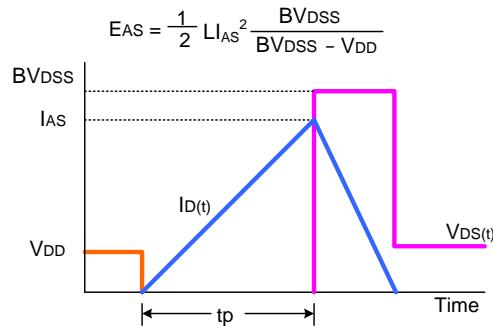
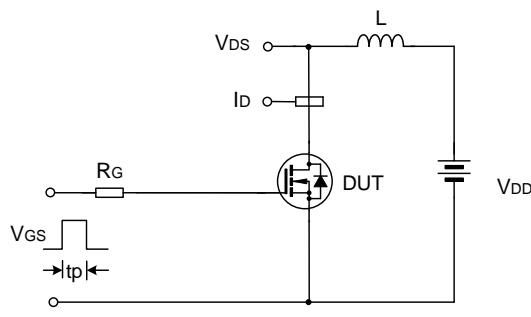
TYPICAL TEST CIRCUIT



Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform

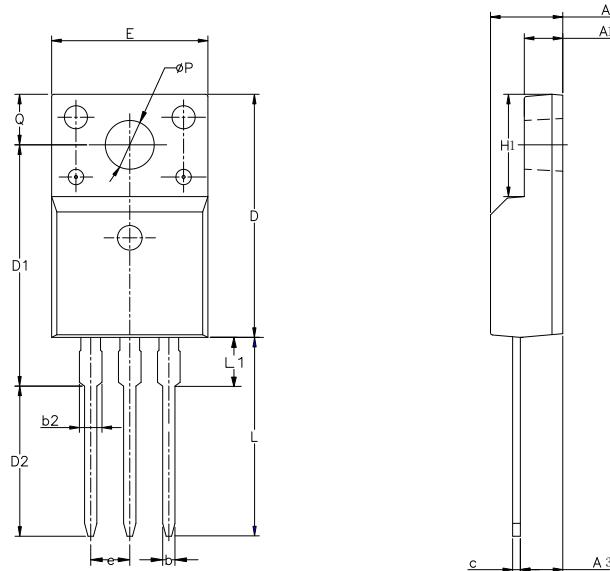


Unclamped Inductive Switching Test Circuit & Waveform

PACKAGE OUTLINE

TO-220FJD-3L

UNIT: mm



SYMBOL	MIN	NOM	MAX
A	4.42	4.70	5.02
A1	2.30	2.54	2.80
A3	2.50	2.76	3.10
b	0.55	0.70	0.85
b2	—	—	1.29
c	0.35	0.50	0.65
D	15.25	15.87	16.25
D1	13.97	14.47	14.97
D2	10.58	11.08	11.58
E	9.73	10.16	10.36
e	2.54BCS		
H1	6.40	6.68	7.00
L	12.48	12.98	13.48
L1	—	—	2.00
ØP	3.00	3.18	3.40
Q	3.05	3.30	3.55

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Part No.: SVFP18N60FJD

Document Type: Datasheet

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Rev.: 1.1

Revision History:

1. Modify Electrical schematic and TYPICAL TEST CIRCUIT
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Rev.: 1.0

Revision History:

1. First release
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